	Туре	L #	Hits	Search Text	DBs	Time Stamp	1 1	Er
1	BRS	L1	7	(spin\$4 or	USPAT; EPO;	2006/02/16 17:41		

	Туре	L #	Hits	Search Text	DBs	Time Stamp	en	De fi	ro
2	BRS	L2	2	or wafer) with (spin\$4 or rotat\$4) and	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/02/16 17:49			

	Type	L #	Hits		DBs	Time Stamp	mm en	Er ro r De fi ni ti	Er ro rs
3	BRS	L 3	13	wafer) with	USPAT; EPO;	2006/02/16 17:44			

	Туре	L #	Hits	Search Text	DBs	Time Stamp	mm en	Er ro r De fi ni ti	Er ro rs
1	BRS	L 5	7	(spin\$4 or	USPAT; EPO;	2006/02/16 17:43			

	Туре	L #	Hits		DBs	Time Stamp	en	Er ro r De fi ni ti	Er ro rs
E)	BRS	L6 ·	49	(substrate or wafer) with	TICDAT. FDO.	2006/02/16 17:48			

	Type	L #	Hits		DBs	Time Stamp	en	Er ro r De fi ni ti	Er ro rs
6	BRS	L7	14	(substrate or wafer) with	USPAT; EPO;	2006/02/16 17:44			

	Туре	L #	Hits	Search Text	DBs	Time Stamp	De fi	Erors	
7	BRS	L8	2	(substrate or wafer) with	USPAT; EPO;	2006/02/16 17:45			

	Туре	L #	Hits	Search Text	DBs	Time Stamp	en	Er ro r De fi ni ti	Er ro rs
8	BRS	L9	4	(substrate or	TICDAT. EDO.	2006/02/16 17:45			

	Type	L#	Hits	Search Text	DBs	Time Stamp	en	Er ro r De fii ni ti	Er ro rs
9	BRS	L10	1	(substrate or	USPAT; EPO;	2006/02/16 17:45			

	Type	L #	Hits	Search Text	DBs	Time Stamp	en	Er ro r De fi ni ti	Er ro rs
10	BRS	L11	12	(substrate or wafer) with	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/02/16 17:45			

	Type	L#	Hits	Search Text	DBs	Time Stamp	en	Er ro r De fii ni ti	Er ro rs
11	BRS	L12	2	(substrate or wafer) with	USPAT; EPO;	2006/02/16 17:46			

	Туре	L #	Hits		DBs	Time Stamp	Co mm en ts	Dе	Er ro rs
12	BRS	L13	1	(substrate or wafer) with	USPAT; EPO;	2006/02/16 17:46			

	Type	L #	Hits	Search Text	DBs	Time Stamp	Co mm en ts	De	Er ro rs
13	BRS	L14	0	(substrate or wafer) with	USPAT; EPO;	2006/02/16 17:46			

	Туре	L #	Hits	Search Text	DBs	Time Stamp	1	 Er ro rs
14	BRS	L15		(substrate or wafer) with	USPAT; EPO;	2006/02/16 17:46		

	Type	L #	Hits	Search Text	DBs	Time Stamp	en	Er ro r De fi ni ti	Er ro rs
15	BRS	L16	4	(substrate or	TICDATE PDO.	2006/02/16 17:46			

	Type	L #	Hits	Search Text	DBs	Time Stamp	1	Er ro rs
16	BRS	L17	2	(substrate or wafer) with	USPAT; EPO;	2006/02/16 17:46		

	Type	L #	Hits	Search Text	DBs	Time Stamp	en	Er ro r De fi ni ti	Er ro rs
17	BRS	L19	39	(substrate or wafer) with	TICDAT. FDO.	2006/02/16 17:47			

	Type	L #	Hits	Search Text	DBs	Time Stamp	en	De fi	Er ro rs
18	BRS	L20	2	("438"/\$).ccls. and (coat\$6 or spray\$4 or spin\$4 adj coat\$4) with (substrate or wafer) and pump and (substrate or wafer) with (spin\$4 or rotat\$4) and (fluid or liquid) with (sens\$4 or detect\$5) and valve and buffer near tank	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/02/16 17:47			

	Туре	L #	Hits	Search Text	DBs	Time :	Stamp	Co mm en ts	De fi	Er ro rs
19	BRS	L21	2	(spin\$4 or	USPAT; EPO;	2006/0 17:47	2/16			

	Туре	L #	Hits	Search Text	DBs	Time Stamp	en	Er ro r De fi ni ti	Er ro rs
20	BRS	L22	0	(438/781).ccls. and (coat\$6 or spray\$4 or spin\$4 adj coat\$4) with (substrate or wafer) and pump and (substrate or wafer) with (spin\$4 or rotat\$4) and (fluid or liquid) with (sens\$4 or detect\$5) and valve and buffer near tank	USPAT; EPO;	2006/02/16 17:48			

		Туре	L #	Hits	Search Text	DBs	Time Stam	p mm er	Er ro r De fi ni ti	Er ro rs
2:	1	BRS	L23	1	(spins4 or	USPAT; EPO;	2006/02/16 17:48			

	Туре	L #	Hits	Search Text	DBs	Time Stamp	mm en	Er ro r De fi ni ti	ro
22	BRS	L24	0	(spins4 or	תרסוד, בים	2006/02/16 17:48			

	Type	L #	Hits	Search Text	DBs	Time	Stamp	en	Er ro r De fi ni ti	
23	BRS	L26	1	(spin\$4 or rotat\$4) and	TICDAT. EDO.	2006/ 17:49	02/16			

	Туре	L #	Hits	Search Text	DBs	Time Stamp	I	Er ro rs
24	BRS	L25	2	(substrate or wafer) with	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2006/02/16 17:49		

	Туре	L #	Hits		DBs	Time Stamp	en	Er ro r De fi ni ti	Er ro rs
25	BRS	L18	3	(substrate or	USPAT; EPO;	2006/02/16 17:49			